

L Number	Hits	Search Text	DB	Time stamp
-	5900	422/99-104.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 14:43
-	5110	422/99-104.ccls. and @pd<19990913	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 14:49
-	240931	422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 11:14
-	8098	(422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and (microfluidic or microscale or mesoscale or microstructure or MEMS or photolithograph\$2)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 11:24
-	7790	((422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and (microfluidic or microscale or mesoscale or microstructure or MEMS or photolithograph\$2)) and (plate or tray or substrate or surface)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 11:21
-	7513	((422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and (microfluidic or microscale or mesoscale or microstructure or MEMS or photolithograph\$2)) and (plate or tray or substrate or surface) and (well or opening or aperture or microstructures)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 11:22
-	876	(422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and microfluidic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 11:22
-	532	((422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and microfluidic) and (lid or cover or coverplate or cap)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 11:30
-	1201	(422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and (microfluidic or microscale or mesoscale)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 11:24
-	688	((422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and (microfluidic or microscale or mesoscale)) and (lid or cover or coverplate or cap)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 11:31
-	9	("5561065") or ("6103199") or ("5597731") or ("6136273") or ("6455055")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 11:26
-	3297	((422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and (microfluidic or microscale or mesoscale or microstructure or MEMS or photolithograph\$2)) and (lid or cover or coverplate or cap)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 11:30

-	798	((422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and (microfluidic or microscale or mesoscale or microstructure or MEMS or photolithograph\$2)) and (lid or cover or coverplate or cap)) and ((raised or protrud\$3 or extend\$3) with (well or aperture or opening or hole or inlet or outlet or canal or conduit or channel))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 11:34
-	355	((422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and (microfluidic or microscale or mesoscale)) and (lid or cover or coverplate or cap)) and @ad<=19990913	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 11:35
-	41	("3785928" "3939623" "4038149" "4252132" "4390403" "4493815" "4908112" "5100627" "5107987" "5126022" "5156285" "5160704" "5180480" "5296114" "5296375" "5304487" "5427946" "5484731" "5486335" "5498392" "5571410" "5585069" "5593838" "5599432" "5603351" "5635358" "5635403" "5637469" "5640995" "5699157" "5726026" "5779868" "5800690" "5842787" "5852495" "5869004" "5876675" "5880071" "5882465" "5885470" "5958343").PN.	USPAT	2002/10/18 14:40
-	3	6251343.URPN.	USPAT	2002/10/18 14:42
-	7440	422/99-104.ccls. or 204/451-453.ccls. or 204/455.ccls. or 204/601-605.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 15:59
-	719	(422/99-104.ccls. or 204/451-453.ccls. or 204/455.ccls. or 204/601-605.ccls.) and @pd>20020101	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 14:45
-	152	((422/99-104.ccls. or 204/451-453.ccls. or 204/455.ccls. or 204/601-605.ccls.) and @pd>20020101) and @ad<=19991022	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 15:35
-	1371	422/99-104.ccls. and @pd>19990913	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 15:35
-	758	(422/99-104.ccls. and @pd>19990913) and @ad<=19991022	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 14:50
-	629	((422/99-104.ccls. and @pd>19990913) and @ad<=19991022) not (((422/99-104.ccls. or 204/451-453.ccls. or 204/455.ccls. or 204/601-605.ccls.) and @pd>20020101) and @ad<=19991022)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 14:51
-	488	((422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and (microfluidic or microscale or mesoscale or microstructure or MEMS or photolithograph\$2)) and (lid or cover or coverplate or cap)) and ((raised or protrud\$3 or extend\$3) with (well or aperture or opening or hole or inlet or outlet or canal or conduit or channel))) and @ad<=19990913	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 14:55

-	598	((422/99-104.ccls. and @pd>19990913) and @ad<=19991022) not (((422/99-104.ccls. or 204/451-453.ccls. or 204/455.ccls. or 204/601-605.ccls.) and @pd>20020101) and @ad<=19991022)) not (((422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and (microfluidic or microscale or mesoscale or microstructure or MEMS or photolithograph\$2)) and (lid or cover or coverplate or cap)) and ((raised or protrud\$3 or extend\$3) with (well or aperture or opening or hole or inlet or outlet or canal or conduit or channel))) and @ad<=19990913)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 15:11
-	987	204/451-453.ccls. or 204/455.ccls. or 204/601-605.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 15:34
-	357	(204/451-453.ccls. or 204/455.ccls. or 204/601-605.ccls.) and @pd>19990913	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 15:35
-	193	((204/451-453.ccls. or 204/455.ccls. or 204/601-605.ccls.) and @pd>19990913) and @ad<=19991022	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 15:58
-	132	((204/451-453.ccls. or 204/455.ccls. or 204/601-605.ccls.) and @pd>19990913) and @ad<=19991022) not (((422/99-104.ccls. and @pd>19990913) and @ad<=19991022) not (((422/99-104.ccls. or 204/451-453.ccls. or 204/455.ccls. or 204/601-605.ccls.) and @pd>20020101) and @ad<=19991022)) not (((422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and (microfluidic or microscale or mesoscale or microstructure or MEMS or photolithograph\$2)) and (lid or cover or coverplate or cap)) and ((raised or protrud\$3 or extend\$3) with (well or aperture or opening or hole or inlet or outlet or canal or conduit or channel))) and @ad<=19990913)) or (((422/\$.ccls. or 436/\$.ccls. or 435/\$.ccls. or 204/\$.ccls.) and (microfluidic or microscale or mesoscale or microstructure or MEMS or photolithograph\$2)) and (lid or cover or coverplate or cap)) and ((raised or protrud\$3 or extend\$3) with (well or aperture or opening or hole or inlet or outlet or canal or conduit or channel))) and @ad<=19990913))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 15:36
-	28222	microstructure	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 15:56
-	784	422/99-104.ccls. or 204/451-453.ccls. or 204/455.ccls. or 204/601-605.ccls.	USOCR	2002/10/18 16:15
-	2	("5443890").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/18 16:40
-	4	("4582684" "4810658" "4880752" "4978503").PN.	USPAT	2002/10/18 16:16
-	18	5443890.URPN.	USPAT	2002/10/18 16:59

-	43	dubrow.in.	USPAT	2002/10/18 16:59
-	104	dubrow.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/10/18 17:00
-	12	dubrow.in. and 422/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/10/18 17:00
-	12	manns.in. and 422/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/10/19 13:32
-	2	("4246339" "4526690").PN.	USPAT	2002/10/19 12:50
-	76	5047215.URPN.	USPAT	2002/10/19 12:50
-	76	5047215.URPN.	USPAT	2002/10/19 12:58
-	1	5961926.pn. and mold\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/10/19 13:32